3: EMC Sub Rack Magic-/Spirit-Kit 11



3.2 Basic Case

- · Advanced EMC shielding is standard
- Dimensions according to IEC 60297
- Rapid assembly
- Top and bottom covers fully perforated
- Aluminium extrusions, electrically conductive
- Side plates, top and bottom covers of pre-galvanized sheet steel
- Scope of delivery:
 - 2 side panels
 - 2 front extrusions
 - 2 internal extrusions
 - 4 tapped strips (6 pcs. for 6 U Version)
 - 2 insulating strips (for backplane, insulated mounting only);
 4 pcs. for 6 U Version
 - 2 top / bottom covers, perforated
 - · Assembly material
 - EMC-gasket for front / side
 - 1 double extrusion (6 U Version only)
- Rear panel has to be ordererd separately



3.2.1 Magic-Kit 11 (IEC 60297)

	Height Width J HP	Backplane Mounting	Depth		
U			240 mm/9.44"	300 mm/11.81"	390mm/ 15.35"
3 U	84	Insulated	11A131-6	11A132-6	11A133-6
3 U	84	Conductive	11A131-7	11A132-7	11A133-7
6 U	84	Insulated	11A161-6	11A162-6	11A163-6
6 U	84	Conductive	11A161-7	11A162-7	11A163-7

3.2.2 Spirit-Kit 11 (IEEE 1101.10 and CompactPCI)

Height	Width	Backplane	Depth		
U	HP	Mounting	240 mm/9.44"	300 mm/11.81"	390mm/ 15.35"
3 U	84	Insulated	11B131-6	11B132-6	11B133-6
3 U	84	Conductive	11B131-7	11B132-7	11B133-7
6 U	84	Insulated	11B161-6	11B162-6	11B163-6
6 U	84	Conductive	11B161-7	11B162-7	11B163-7

3.2.3 Rear Panel

- Galvanized sheet steel
- Scope of delivery:
 - 1 rear panel
- Assembly material included in case

Height	Description	Part-No.
3 U	Rear panel	22-384
6 U	Rear panel	22-684